

Essentials of MOSFETs

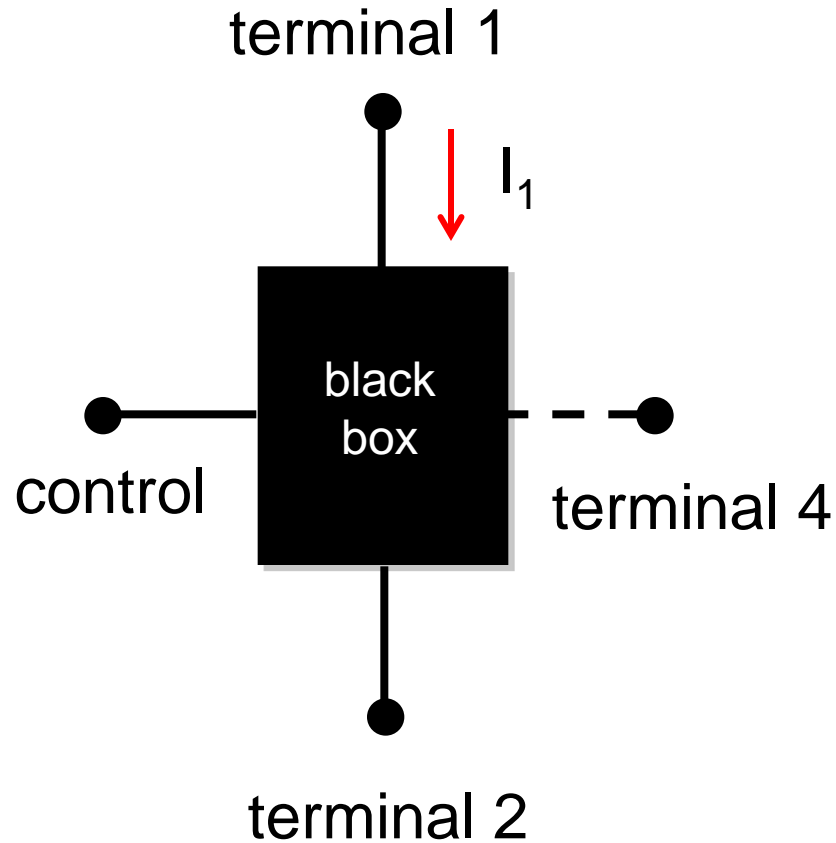
Unit 1: Transistors and Circuits

Lecture 1.6: Unit 1 Recap

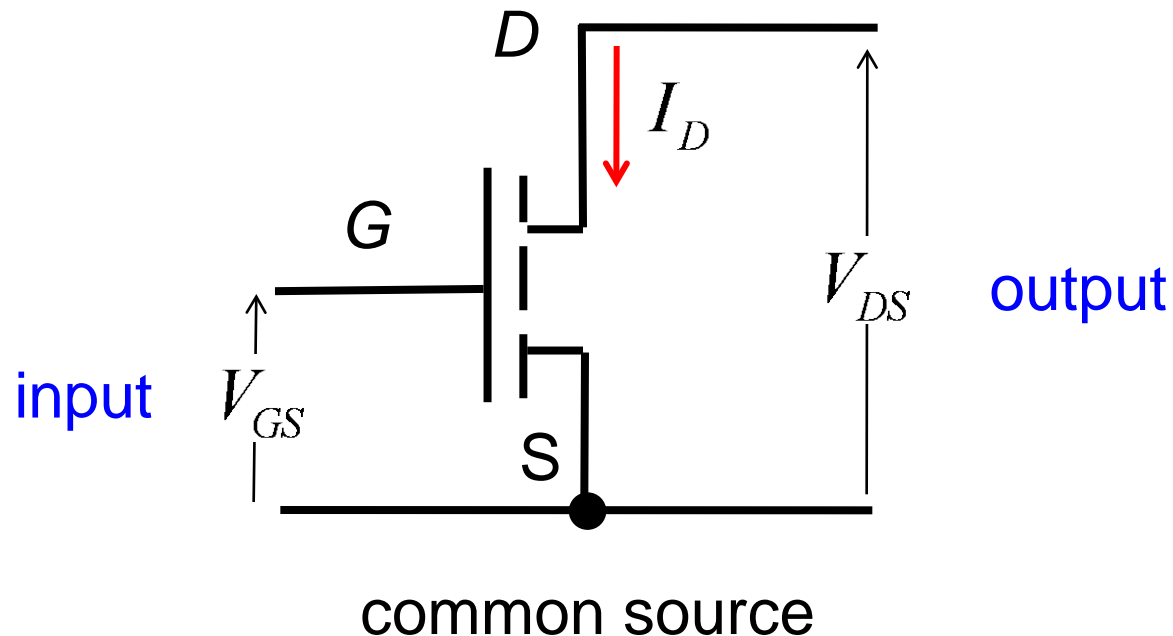
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The transistor as a “black box”



The MOSFET as a 2-port device

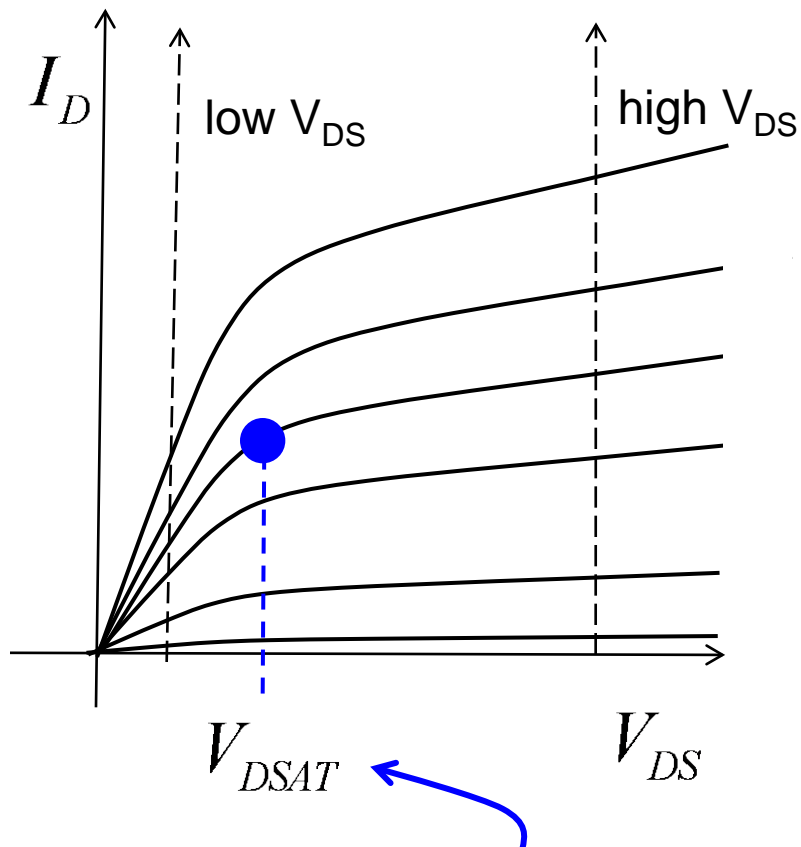


$I_D(V_{GS})$ at a fixed V_{DS} Transfer characteristics

$I_D(V_{DS})$ at a fixed V_{GS} Output characteristics

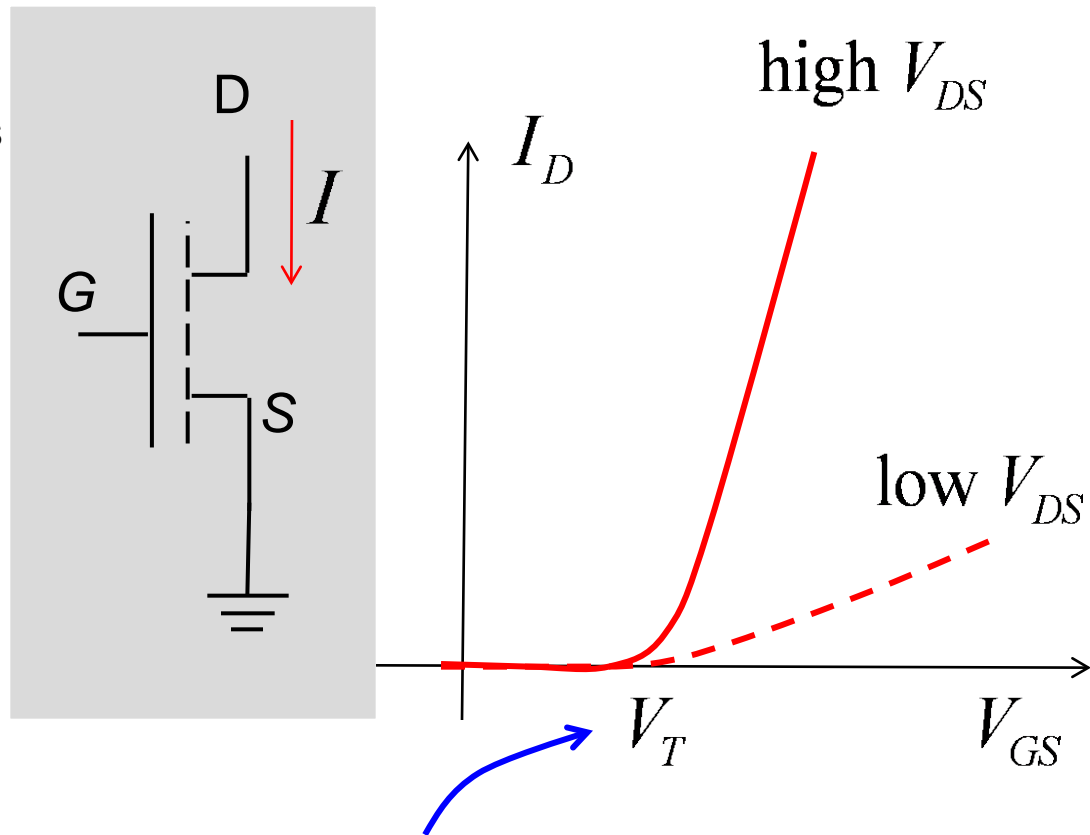
Output vs. transfer characteristics

output characteristics



“saturation voltage”

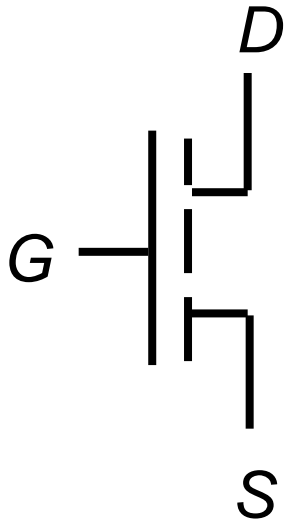
transfer characteristics



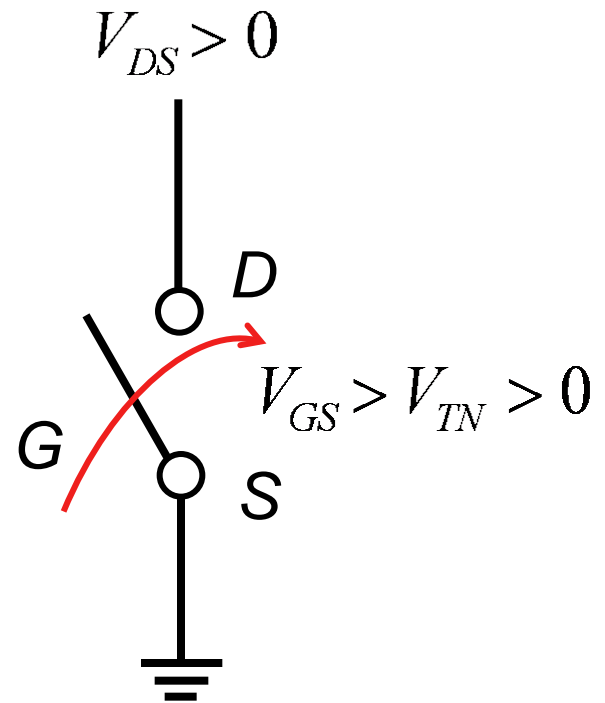
“threshold voltage”

Digital electronics

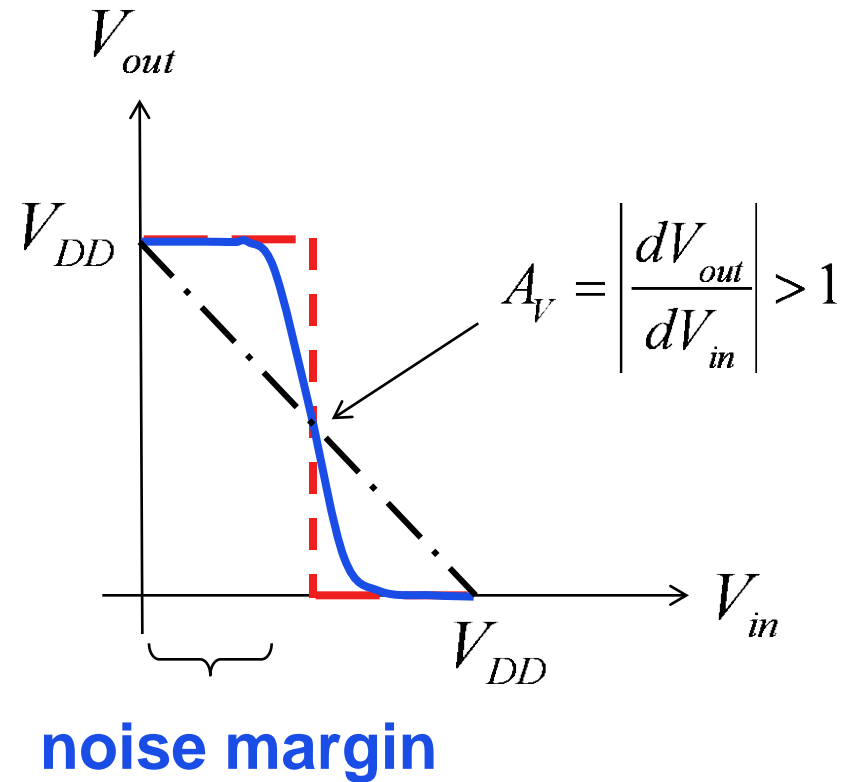
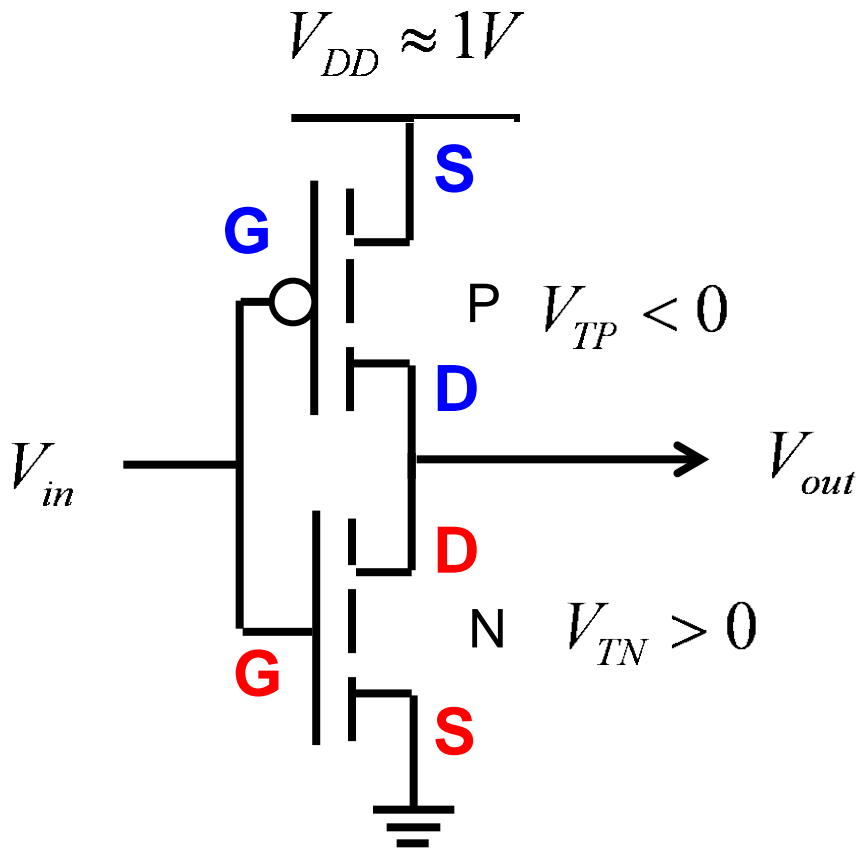
N-MOSFET
symbol



switch



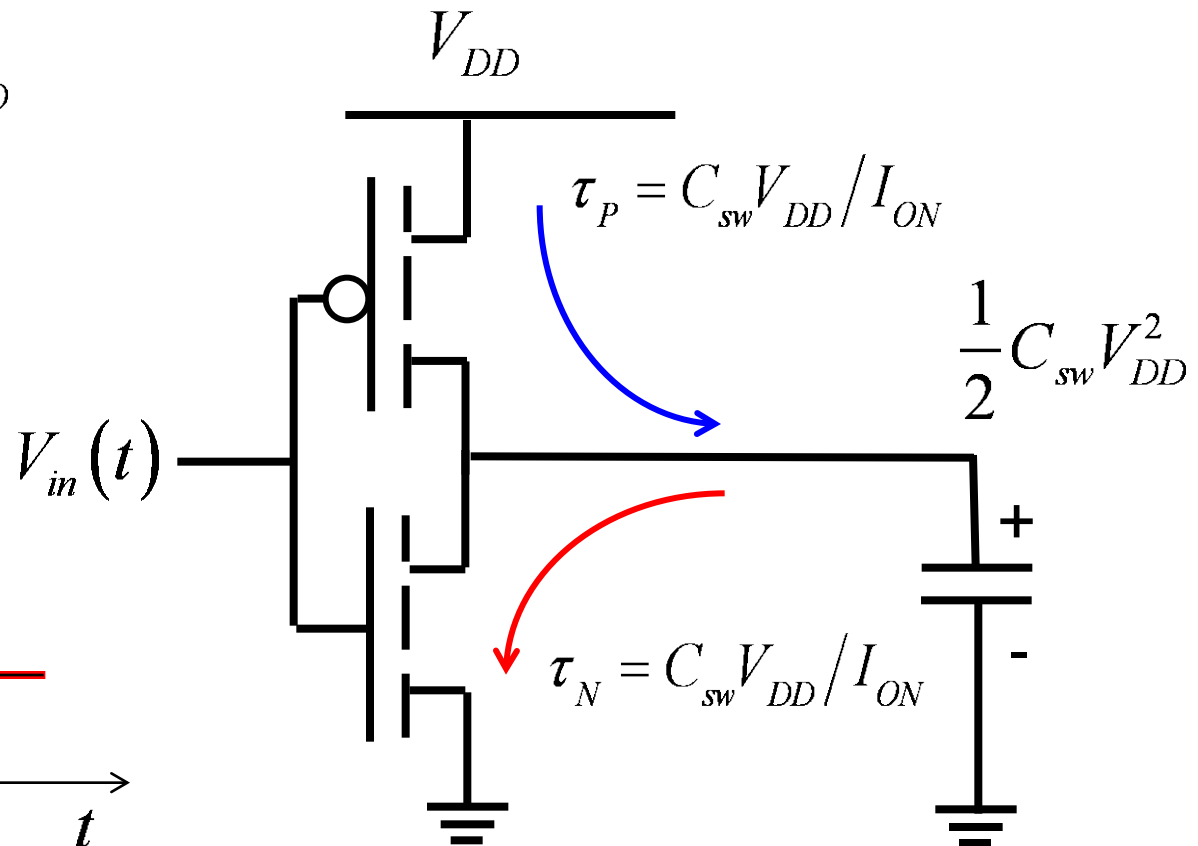
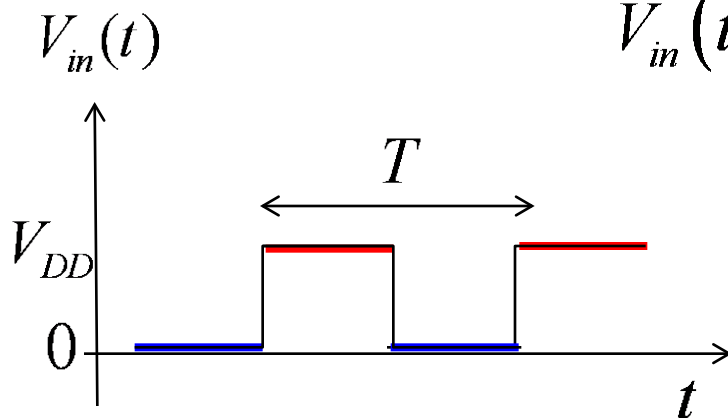
CMOS Inverter



Switching

$$P_{\text{dynamic}} = \alpha f C_S V_{DD}^2$$

$$P_{\text{static}} = N_G I_{\text{OFF}} V_{DD}$$



CMOS speed and power

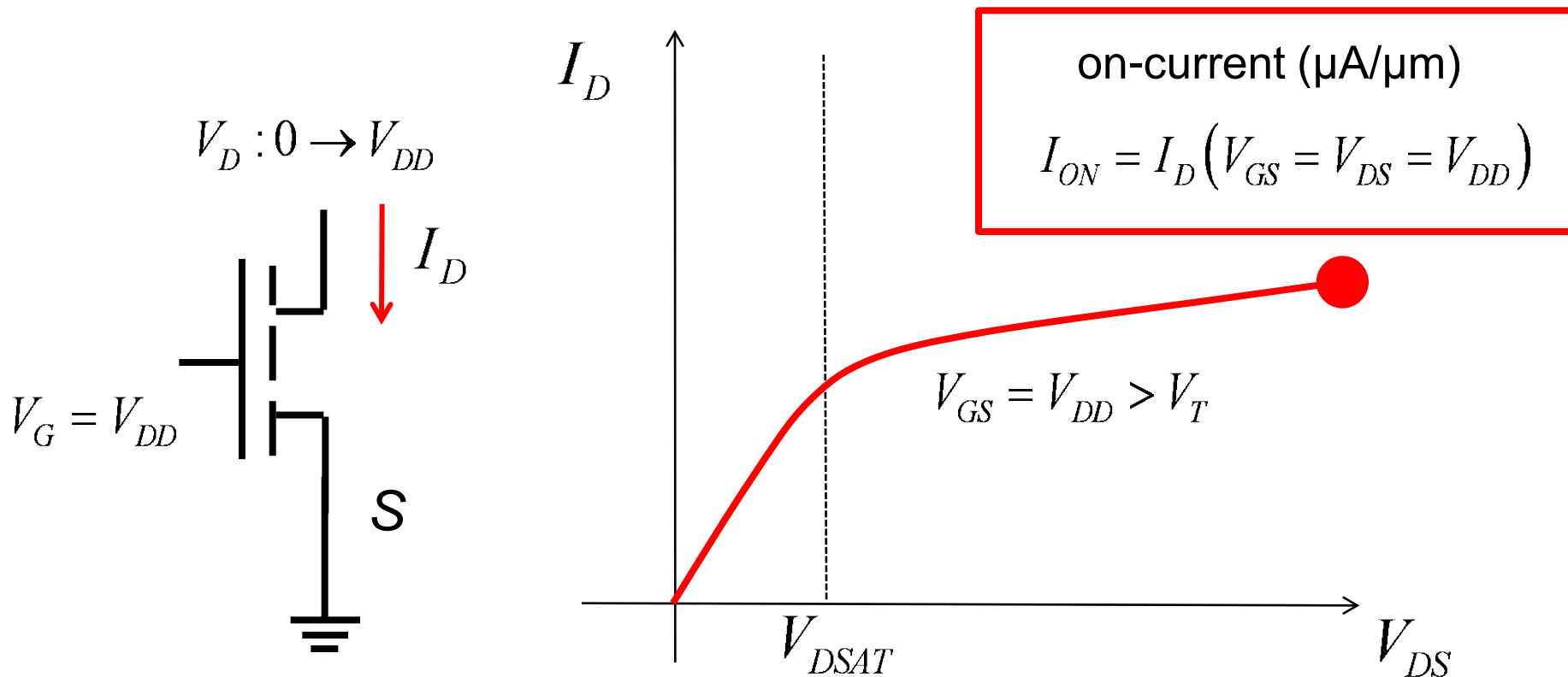
$$\tau = C_{sw} V_{DD} / I_{ON} \quad P_{\text{dynamic}} = \alpha f C_S V_{DD}^2 \quad P_{\text{static}} = N_G I_{OFF} V_{DD}$$

- 1) Higher on-current means higher speed
- 2) Faster operation means more dynamic power
- 3) Lower V_{DD} means lower power
- 4) More leakage means more power dissipation

Key Figures of Merit for digital applications

- 1) On current
- 2) Off-current
- 3) Subthreshold swing
- 4) DIBL

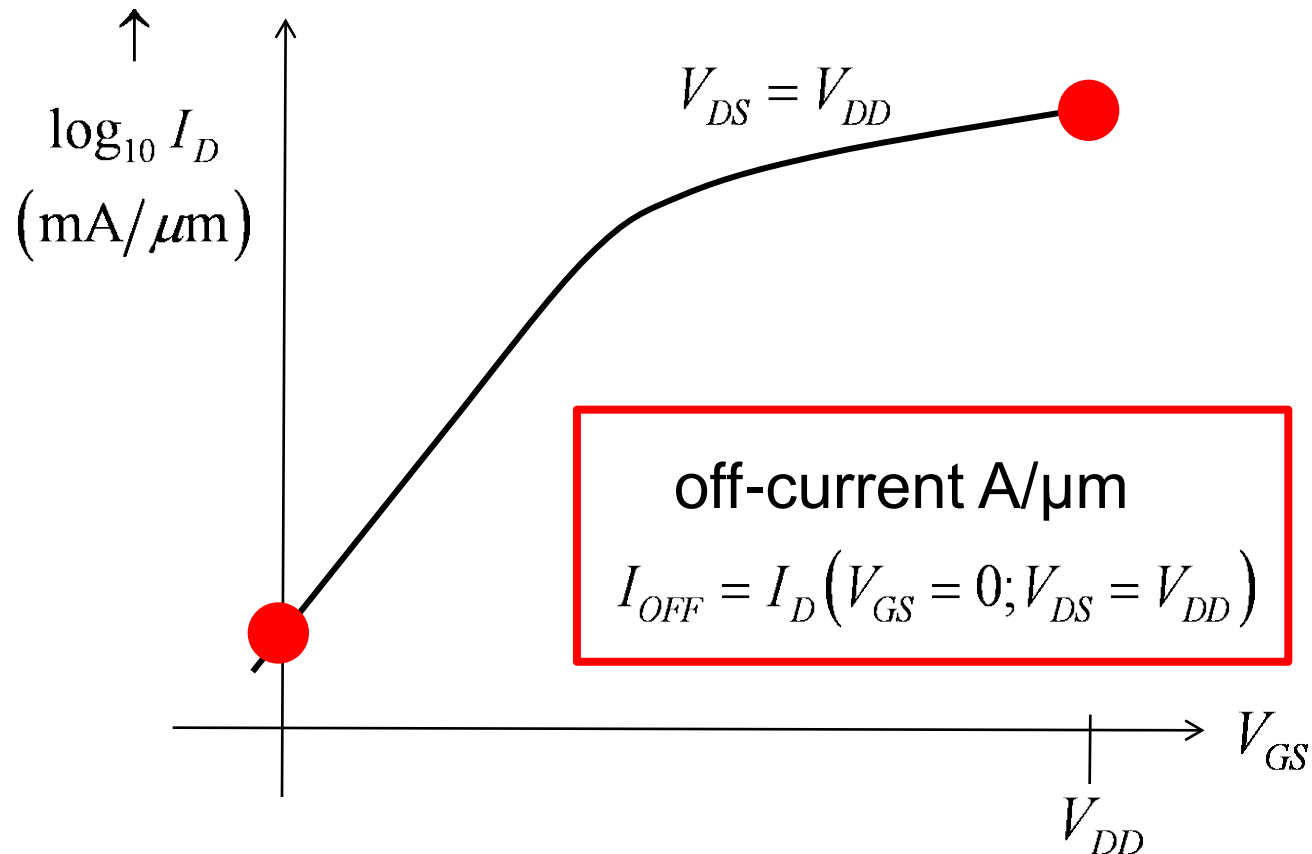
1) On-current



output characteristic:
 I_D vs. V_{DS} at fixed V_{GS}

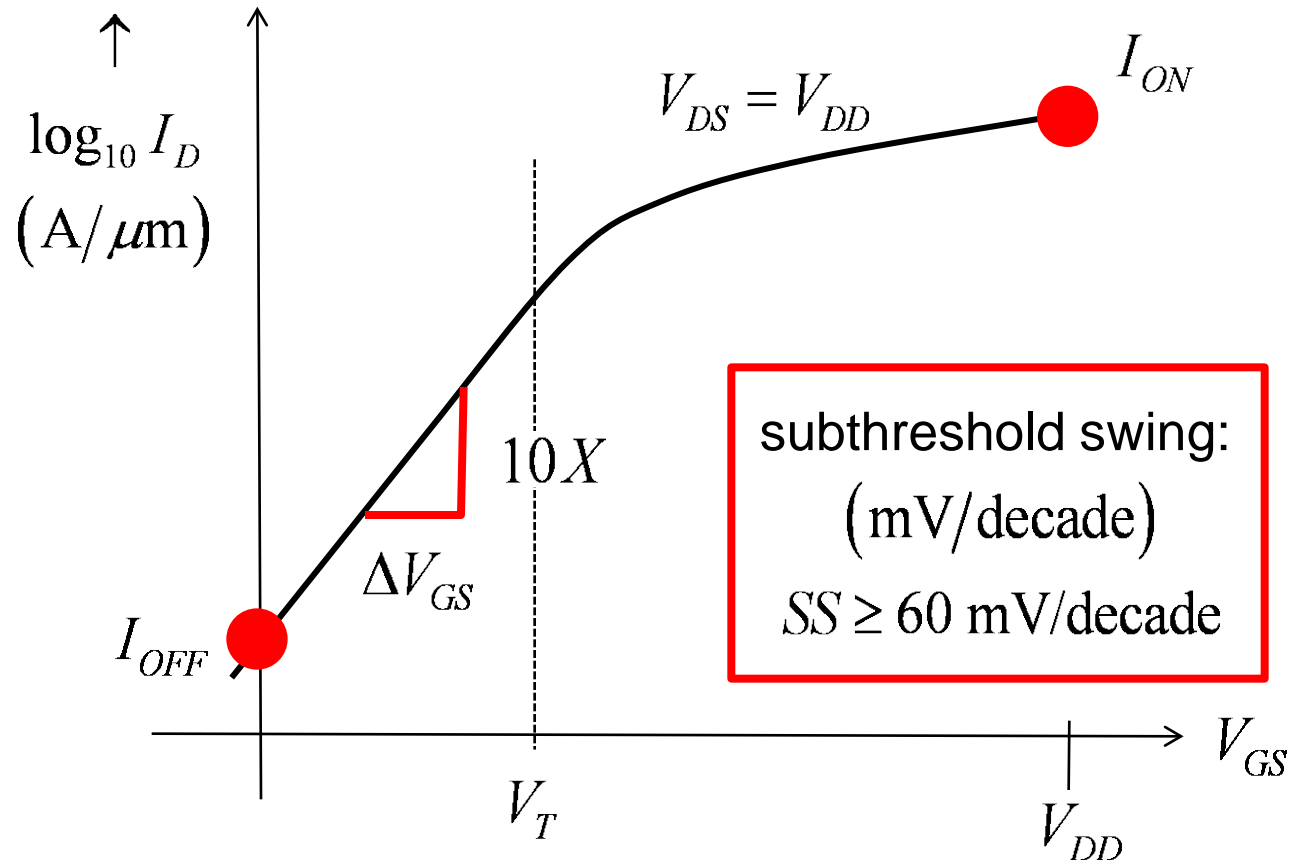
2) Off-current

transfer characteristic on a semi-log plot:



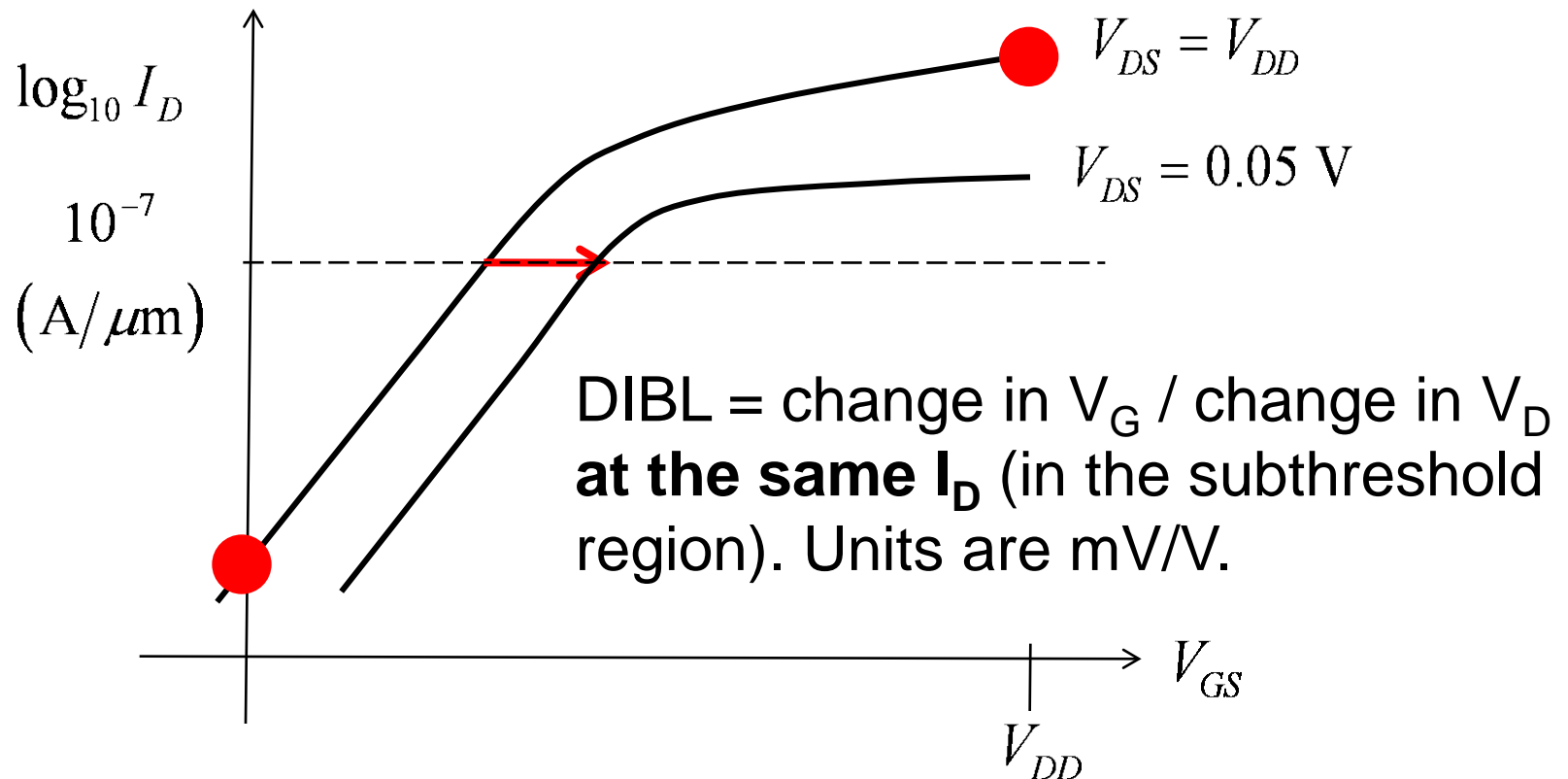
3) The Subthreshold Swing

transfer characteristics:

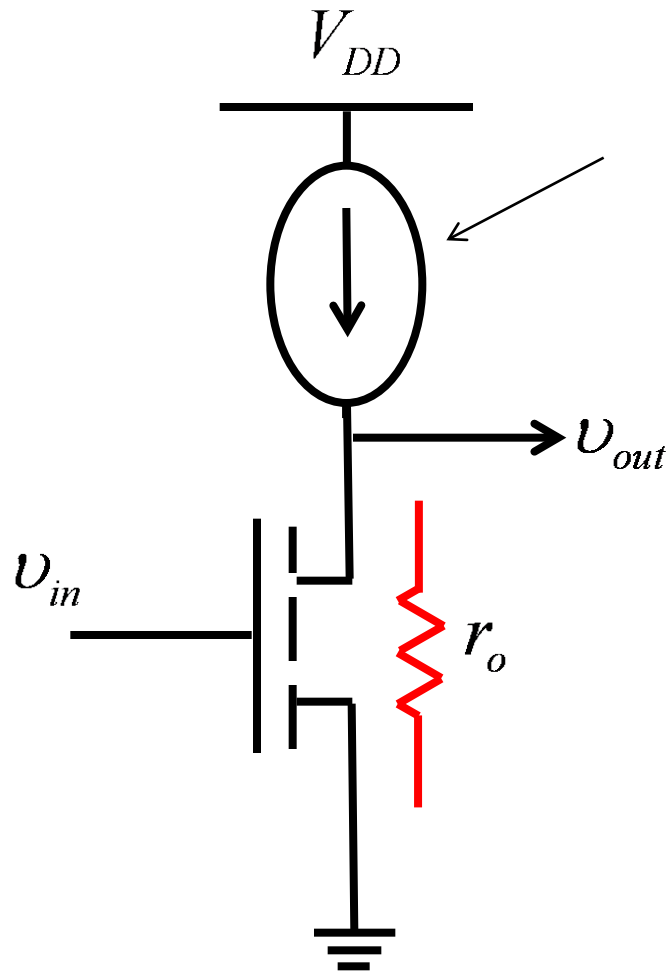


4) DIBL

transfer characteristics:



Analog / RF



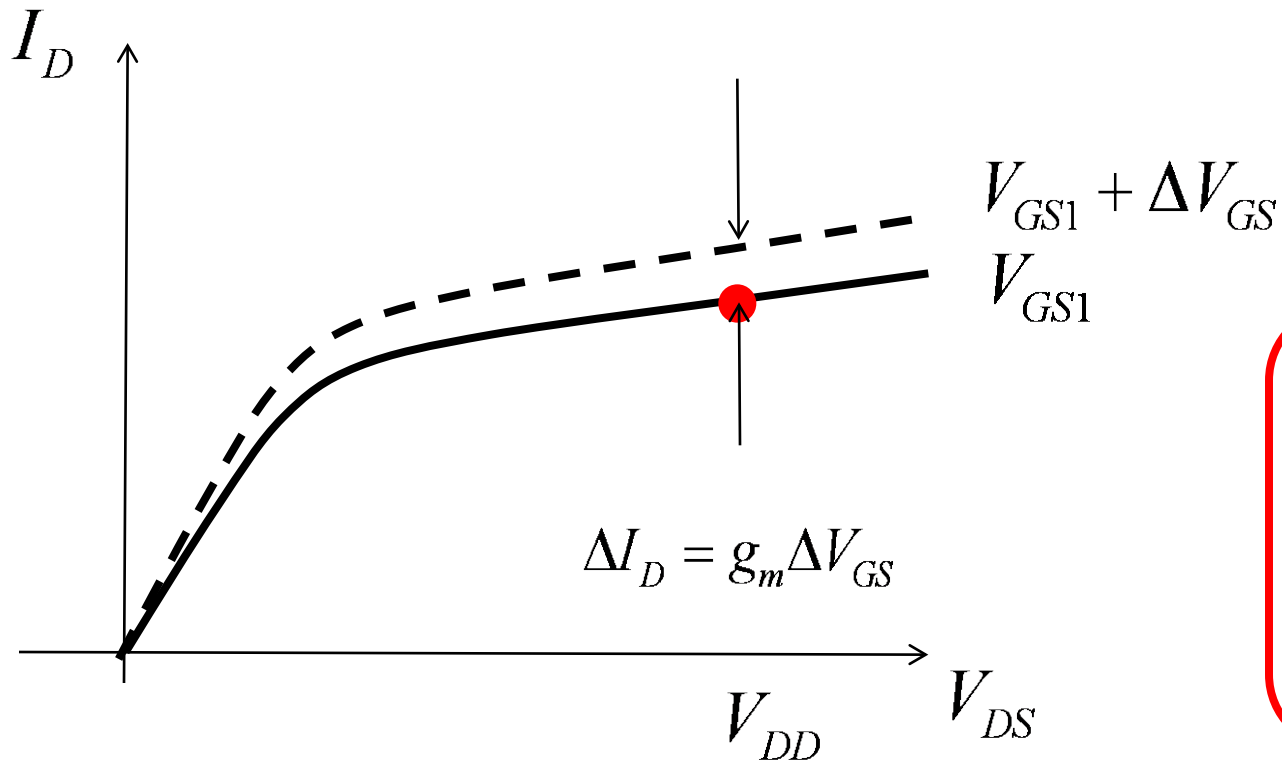
high impedance current source

$$A_v(\max) = -g_m r_o$$

The **transconductance**, g_m , and **output resistance**, r_o , of the MOSFET are important figures of merit.

So is the **self gain**, $g_m r_o$.

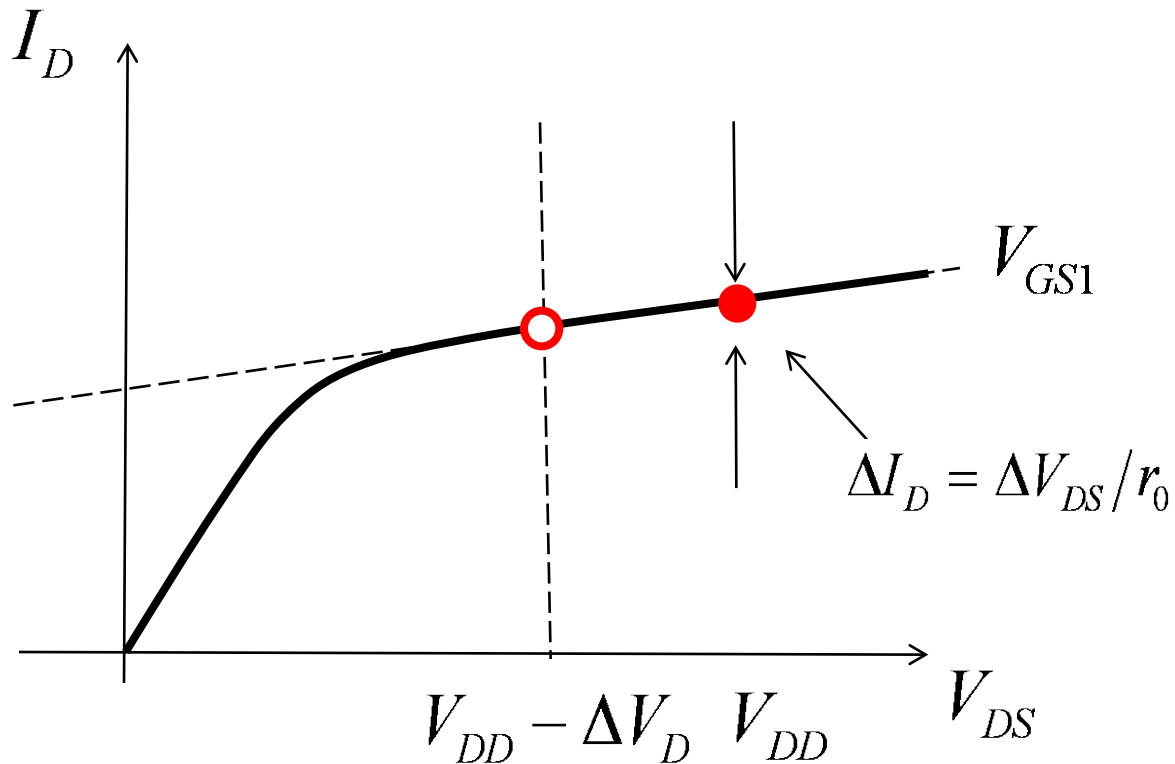
Transconductance



$$g_m \equiv \left. \frac{\partial I_D}{\partial V_{GS}} \right|_{V_{DS}}$$

$(\mu\text{S}/\mu\text{m})$

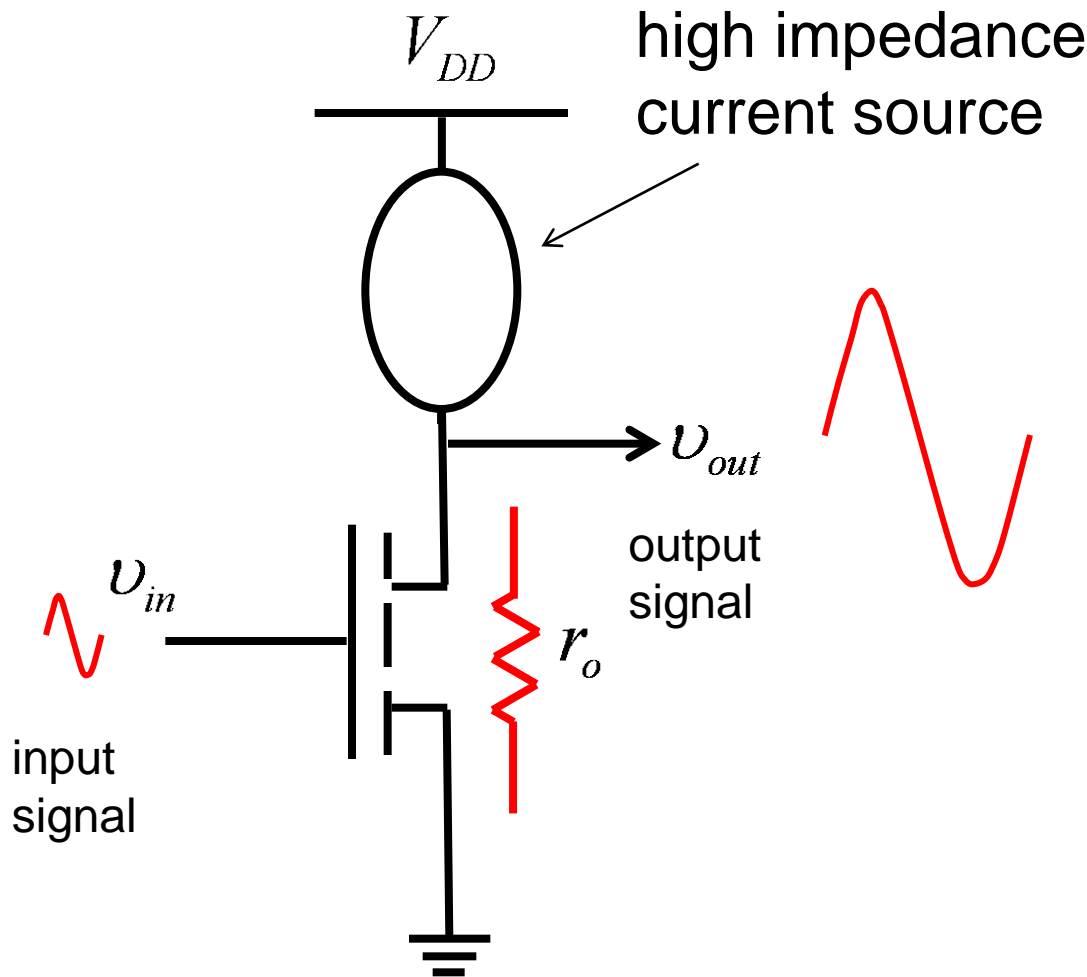
Output resistance



$$r_0 \equiv \left(\left. \frac{\partial I_D}{\partial V_{DS}} \right|_{V_{GS}} \right)^{-1}$$

$\Omega - \mu\text{m}$

Other analog device metrics



$$A_v(\text{max}) = -g_m r_o$$

g_m and r_o are important analog device metrics

But also f_T , f_{max} , linearity, noise, mismatch, etc.

Recap

Given the measured characteristics of a MOSFET, you should be able to determine:

1. on-current: I_{ON}
2. off-current: I_{OFF}
3. subthreshold swing, SS
4. drain induced barrier lowering: DIBL

5. output resistance: r_o
6. *transconductance*: g_m

threshold voltage: $V_T(\text{lin})$ and $V_T(\text{sat})$

drain saturation voltage: V_{DSAT}

Our goal in this course is to understand these device metrics and parameters.

Two types of compact models

In the course, we will distinguish between two different types of compact models:

1) Compact physical models

These models aim to describe a device in terms of a few parameters with strong physical significance. These kinds of models are useful for device characterization, process monitoring, and for the conceptual understanding that guides device research.

Our focus in this course is on this type of compact model.

Second type of compact models

2) Compact device models for circuit simulation

These models accurately relate the currents that flow into a device's terminals to the voltages on the leads **in a form suitable for use in numerical circuit simulation programs**. To describe everything relevant to a circuit, these models are more complex, but the core of the model is usually a compact physics model.

These kinds of compact models play a critical role in connecting semiconductor R&D and manufacturing to product design.

Summary

Be sure that you are familiar with the shape of a transistor IV characteristic (linear and saturation regions, sub-threshold and above threshold, output and transfer characteristics, etc.)

You should also be familiar with the key metrics for digital applications (on- and off-currents, SS, DIBL) and for analogue applications (and how to extract them from measured IV characteristics).

Next, in Unit 2, we will start looking inside the transistor “black box”.